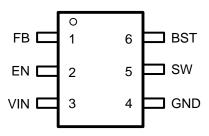
I: KM GNF K	I: D: F: KDBG	I: D: BLKBIMBHG
1)		

Over operating free-air temperature unless otherwise noted(1)

DESCRIPTION	MIN	MAX	UNIT
BST	-0.3	40	V
VIN, SW, EN	-0.3	34	V
FB	-0.3	5.5	V
Operating junction temperature ⁽²⁾	-40	125	°C
Storage temperature T _{STG}	-65	150	°C



Top View: TSOT23-6L, Plastic

(1)

(2)

G: F GH I BG NG MBH MBH



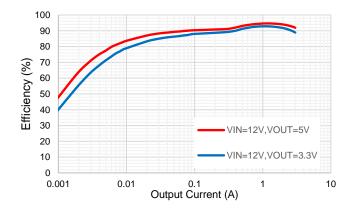
BST	6	Power supply for the high-side power MOSFET gate driver. Must connect a 0.1uF or greater ceramic capacitor between BST pin and SW node.			
I: K: F M F	<	EGENTEH G	FEG	F: Q	NGBM
1: K: F M F	(EGENEH G	FEG	F: Q	NGBM

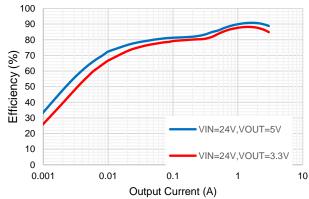
L M ,,

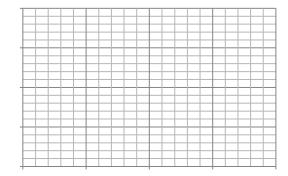
LRF HE	I: K: F M K	M LM HG BMBHG	MRI	F: Q	NGBM
d .	: ebb				
Eb	b				
L b ab					
				•	
L L M	b				

l b



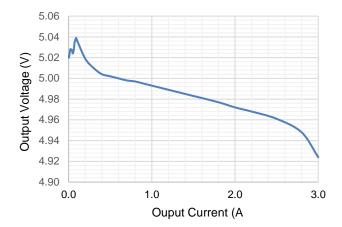


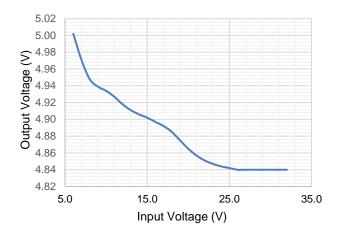




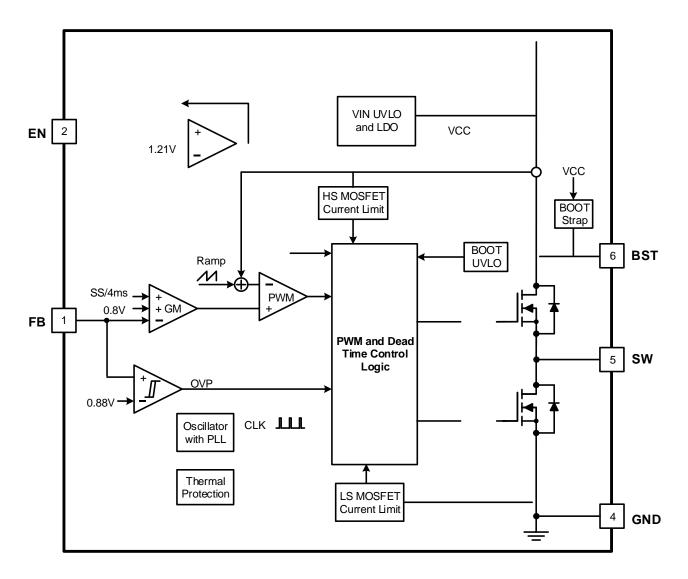


L M,,









b 2 b e e d b



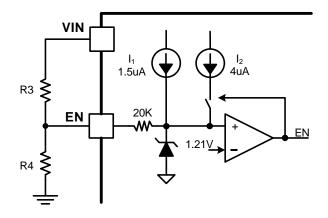
H b

OBG I

N Oe Ed NOEH

ë L





L b ab G Kb b



I d Eb[:] b Ab F

H O e I b Fbb H b

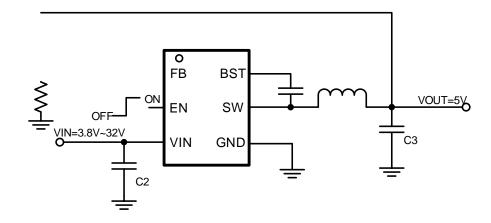
ILFP db F



: E K e b



: :: M b e: eb b



b ', -ОВ '.О,: Н

b I

Design Parameters	Example Value
Input Voltage	24V
Output Voltage	5V
Output Current	3A
Output voltage ripple (peak to peak)	±0.3V
Switching Frequency	400kHz



L M,,

B b L e b

(3)

•

•

B Leb

_____(4)

•

____ (5)

: : H b L e b

______(6)

•



H b L e b

H dK b bb Le b

_____ (11)

M e K · e

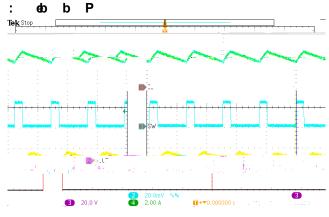


Figure 16. SW node waveform and Output Ripple VIN=24V, IOUT=3A

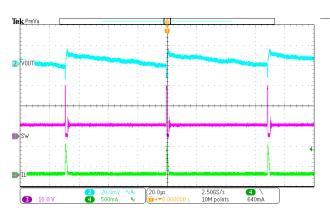


Figure 17. SW node Waveform and Output Ripple VIN=24V, IOUT=10mA

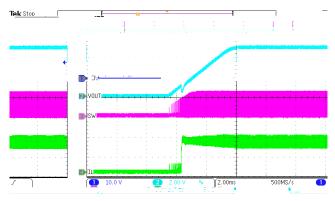


Figure 18. Power Up VIN=24V, VOUT=5V, IOUT=3A

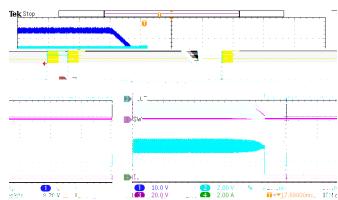


Figure 19. Power Down VIN=24V, VOUT=5V, IOUT=3A

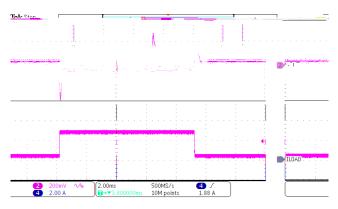


Figure 20. Load Transient VOUT=5V, IOUT=0.3A to 2.7A, SR=250mA/us



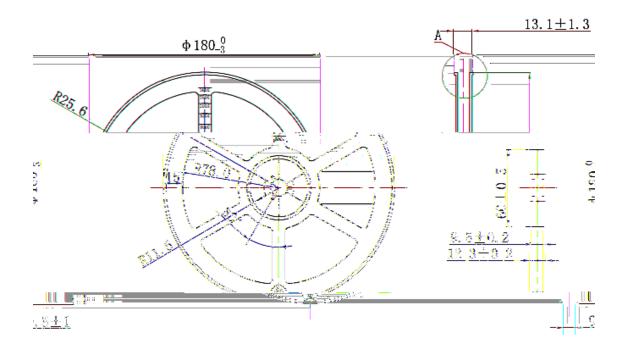
Figure 21. Load Transient VOUT=5V, IOUT=0.75A to 2.25 A, SR=250mA/us



GHM 3

1.







b b b

